



## Applications

- traffic signaling.
- backlighting (illuminated advertising , general lighting).
- interior and exterior automotive lighting.
- substitution of micro incandescent lamps.
- portable light source (e.g. bicycle flashlight).
- signal and symbol luminaire for orientation.
- marker lights (e.g. steps, exit ways, etc).
- decorative and entertainment lighting.
- indoor and outdoor commercial and residential architectural lighting.

## Application Notes

- Pressure or stress can damage the encapsulating material and affect the reliability of the LED.  
Precaution should be taken to avoid pressure on the LED encapsulating surface.

- Static electricity and surge damage the LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

- Handling Indications

Use proper handling techniques to prevent damage to the LED surface. Minimize mechanical stress on the LED surface during processing and handling. Do not touch the emitting surface with sharp objects to avoid scratching or damaging the LED.



**Figure 1**

In general, LEDs should be handled by the sides of the package. Handling instruments should not touch the emitting surface of the LED package.



**Figure 2**

For automated pick-and-place machines, the pickup nozzle should be larger than the size of the LED reflector area to avoid placing excess pressure on the LED surface.

## Selection Guide

Part No.	Dice	Lens Type	luminous Intensity [2] Iv (cd)@ 350 mA		Φv (lm) [2] @ 350 mA		Viewing Angle [1]
			Min.	Typ.	Min.	Typ.	2 θ 1/2
KA-1010ZG10ZS	Green (AlGaInN)	WATER CLEAR	12	20	39	65	120 °

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous intensity/ luminous Flux: +/-15%.

## Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Value	Unit
Power dissipation	Pt	1.33	W
Junction temperature	TJ	110	°C
Operating Temperature	Top	-40 To +85	°C
Storage Temperature	Tstg	-40 To +85	°C
DC Forward Current [1]	IF	350	mA
Peak Forward Current [2]	IFM	500	mA
Thermal resistance [1]	Rth	47	°C/W

Notes:

1. Results from mounting on PC board FR4 (pad size ≥ 100mm<sup>2</sup> per pad), mounted on pc board-metal core PCB is recommend for lowest thermal Resistance.
2. 1/10 Duty Cycle, 0.1ms Pulse Width.

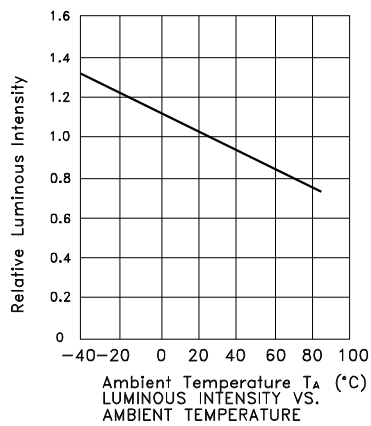
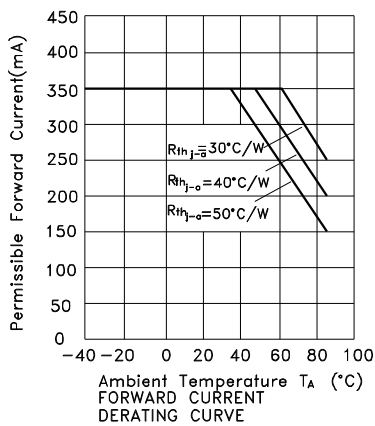
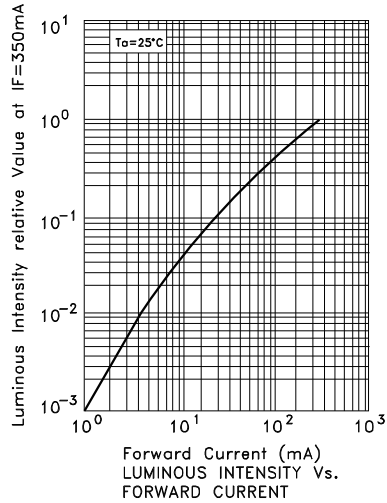
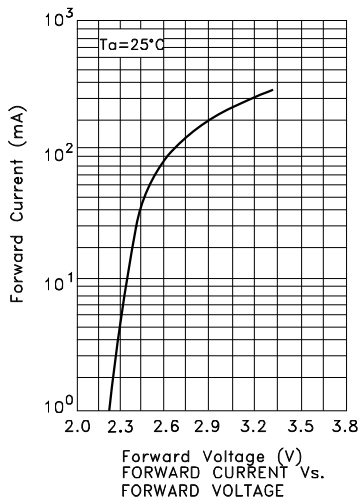
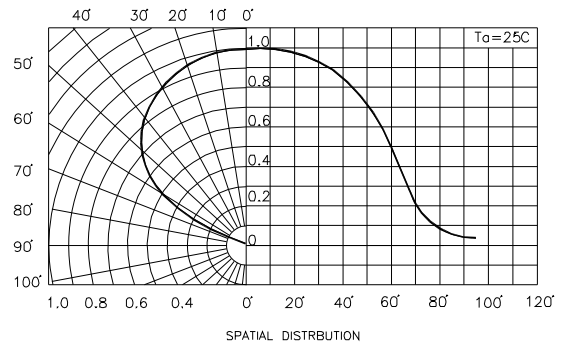
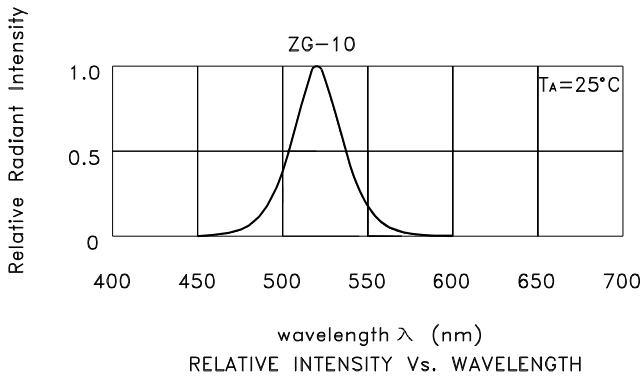
## Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Value	Unit
Wavelength at peak emission IF=350mA [Typ.]	λ peak	520	nm
Dominant Wavelength IF=350mA [Typ.]	λ dom [1]	530	nm
Spectral bandwidth at 50%Φ REL MAX IF=350mA [Typ.]	Δλ	35	nm
Forward Voltage IF=350mA [Min.]	VF [2]	2.7	V
Forward Voltage IF=350mA [Typ.]		3.3	
Forward Voltage IF=350mA [Max.]		3.8	
Temperature coefficient of λ peak IF=350mA, -10 ° C ≤ T ≤ 100 ° C [Typ.]	TC λ peak	0.16	nm/° C
Temperature coefficient of λ dom IF=350mA, -10 ° C ≤ T ≤ 100 ° C [Typ.]	TC λ dom	0.14	nm/° C
Temperature coefficient of VF IF=350mA, -10 ° C ≤ T ≤ 100 ° C [Typ.]	TCv	-2.0	mV/° C

Notes:

1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

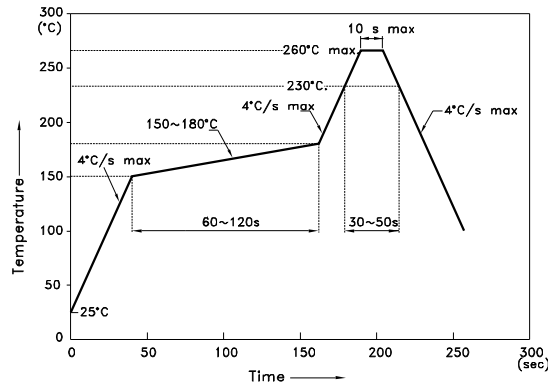
## KA-1010ZG10ZS



## KA-1010ZG10ZS

Reflow soldering is recommended and the soldering profile is shown below.  
Other soldering methods are not recommended as they might cause damage to the product.

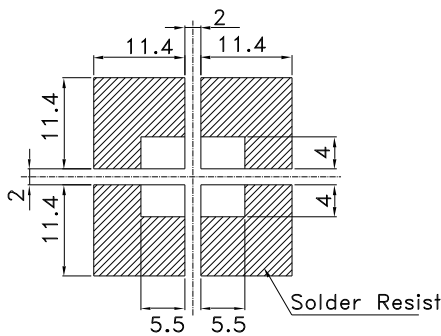
Reflow Soldering Profile For Lead-free SMT Process.



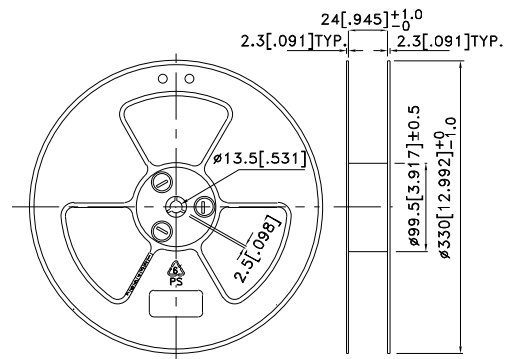
**NOTES:**

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

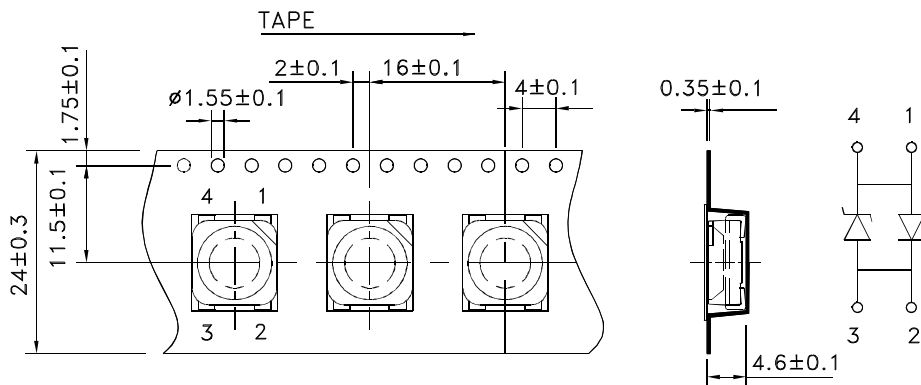
### Recommended Soldering Pattern (Units : mm; Tolerance: ±0.1)



### Reel Dimension

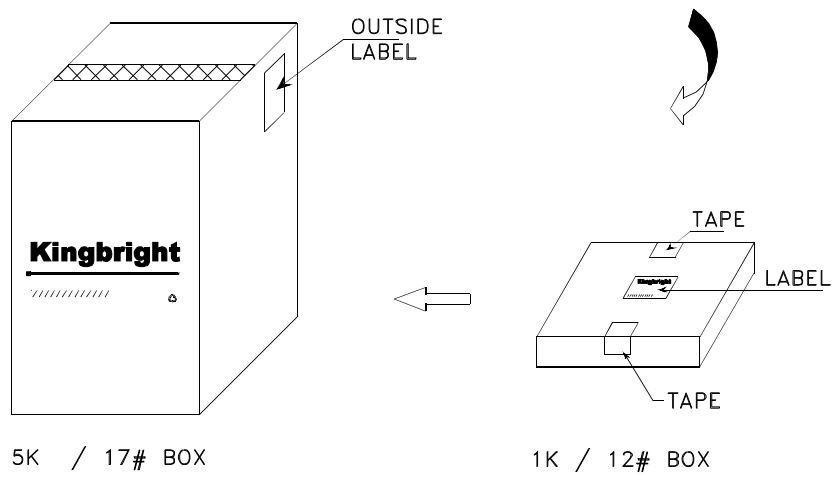
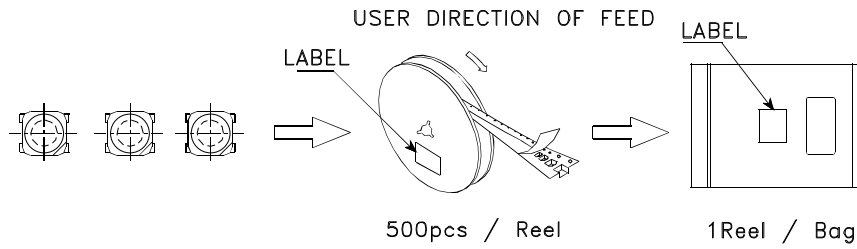



### Tape Specifications (Units : mm)



**PACKING & LABEL SPECIFICATIONS**

**KA-1010ZG10ZS**



<h2>Kingbright</h2>	
P/N0: KA-1010xxx	
QTY: 500 pcs	Q.C. <span style="border: 1px solid black; border-radius: 50%; padding: 2px;">Q C xx xx xxxx PASSED</span>
S/N: XXXX	
CODE: XXX	
LOT NO:	
 XXXXXXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	